

# Electrical Characteristics $\text{CuFe}_2\text{O}_4$ Ceramics With and Without $\text{Al}_2\text{O}_3$ for Negative Thermal Coefficient (NTC) Thermistor

Wiendartun<sup>1)</sup>, Dani Gustaman Syarif<sup>2)</sup>, Arief Permadi<sup>1)</sup>

<sup>1)</sup> Jurusan Fisika FMIPA UPI, Jl. Dr. Setiabudhi 229 Bandung, email: wien@upi.edu

<sup>2)</sup> PTNBR BATAN, Jl. Tamansari 71 Bandung,, email: [danigusta@yahoo.com](mailto:danigusta@yahoo.com)

## ABSTRACT

In order to get capability in thermistor production in Indonesia, a study on electrical characterization of  $\text{CuFe}_2\text{O}_4$  base-ceramics with  $\text{Al}_2\text{O}_3$  addition has been performed. The  $\text{Al}_2\text{O}_3$  addition was done with various concentrations namely 0, 1 dan 5 mole %. Powder of  $\text{CuO}$ ,  $\text{Fe}_2\text{O}_3$  and  $\text{Al}_2\text{O}_3$  was mixed and ground. The mixture was pressed with pressure of 3,9 ton/cm<sup>2</sup> to form pellets. The pellets was then sintered at 1100°C for 2 jam in air. After sintering, two sides of some sintered pellets were coated with silver paste and fired at 600°C for 10 minutes. Some of coated samples were heat treated at 500°C for 5 minutes in  $\text{N}_2$  gas. These pellets were analyzed using x-ray diffraction (XRD). R-T and ageing characteristics were evaluated. From the XRD data, it was known that the  $\text{CuFe}_2\text{O}_4$  ceramics produced crystallized in tetragonal spinel. According to the electrical data, the thermistor constant (B) and sensitivity (a) increases due to the addition of  $\text{Al}_2\text{O}_3$ . It was known from the ageing test that only the ceramics with 0 and 1 mole %  $\text{Al}_2\text{O}_3$  fit the electrical stability condition.

**Keywords** : Ceramic,  $\text{CuFe}_2\text{O}_4$ ,  $\text{Al}_2\text{O}_3$ , thermistor, NTC, ageing.

## 1. INTRODUCTION

NTC thermistor are widely used due to its capability to be applied in many applications such as temperature sensor, electric current limiter, flowrate meter and pressure sensor[1]. It is known that generally the NTC thermistor is made of ceramic having structure of spinel of  $\text{AB}_2\text{O}_4$  where A is the ion occupies tetrahedral position and B is the ion occupies octahedral position[2-10]. Many works have been performed in order to improve the characteristic of the NTC thermistor having spinel structure [6,7,11]. Theoretically, the addition of additive such as  $\text{Al}_2\text{O}_3$  may change the electrical characteristics of  $\text{CuFe}_2\text{O}_4$  ceramic.

When the additive of  $\text{Al}_2\text{O}_3$  is added to the  $\text{CuFe}_2\text{O}_4$  ceramic, the characteristics of the  $\text{CuFe}_2\text{O}_4$  ceramic may change because two conditions may occur namely, the first,  $\text{Al}_2\text{O}_3$  dissolves in the  $\text{CuFe}_2\text{O}_4$  through substituting Cu ions or Fe ions, the second,  $\text{Al}_2\text{O}_3$  does not dissolve and segregate at grain boundaries. When the substitution of Fe or Cu ions results in an increase of electron in the conduction band, the electrical resistivity of the  $\text{CuFe}_2\text{O}_4$  will decrease. On the contrary, when the second condition occurs, the

electrical resistivity may increase due to a change in microstructure. In this work, the effect of the  $\text{Al}_2\text{O}_3$  addition on the electrical characteristics, especially the electrical stability, of the  $\text{CuFe}_2\text{O}_4$  ceramic was studied.

## 2 . METHODOLOGY

Powder of  $\text{CuO}$ ,  $\text{Fe}_2\text{O}_3$  and additive of  $\text{Al}_2\text{O}_3$  ( 0, 1 and 5 mole %) were mixed and ground. The composition is shown at Table 1. After calcination at 800°C for 2 hours, the mixture was ground. The ground powder was pressed with pressure of 3,9 ton/cm<sup>2</sup> to form pellets. The green pellets were sintered at 1100°C for 2 hours in furnace air. Two sides of some sintered pellets were coated with silver paste. Some silver coated samples were heat treated at 500°C for 5 minutes in  $\text{N}_2$  gas. Structure of the sintered pellet was analyzed using x-ray diffraction (XRD). For electrical characterization, the electrical resistance of the pellets was measured at various temperatures. The measurement was done before and after ageing test. The ageing test was conducted by measuring the resistance of the pellet at room temperature after heating at 150°C in every several hours.

Thermistor constant (B) is the gradient of the ln Resistivity vs 1/T curve which is constructed based on equation (1) [2-11] expressing NTC characteristic. Sensitivity ( $\alpha$ ) was calculated using equation (2)[6].

$$R = R_0 \cdot \text{Eksp.}\left(\frac{B}{T}\right) \dots\dots\dots(1)$$

where R = thermistor resistance (Ohm),  $R_0$  = a constant (Ohm), B = Thermistor constant (K) and T = Temperature (K).

$$\alpha = \frac{-B}{T^2} \dots\dots\dots(2)$$

where  $\alpha$  = Sensitifitas termistor,

B = Koefisien termistor dalam °K

T = suhu dalam °K

Activation energy can be calculated using equation (3)[6],

$$B = \frac{\Delta E}{k} \dots\dots\dots(2)$$

Dengan B = Konstanta termistor (°K)

$\Delta E$  = Energi aktivasi (eV),

k = Konstanta Boltzmann ( $\frac{eV}{^\circ K}$ )

Table 1. Sample composition in mole %.

No.	CuO	Fe <sub>2</sub> O <sub>3</sub>	Al <sub>2</sub> O <sub>3</sub>
1.	40	60	0
2.	40	59	1
3.	40	55	5

## 4. RESULTS AND DISCUSSION

### 4.1 XRD Analyses

XRD profiles of CuFe<sub>2</sub>O<sub>4</sub> base-ceramics added with Al<sub>2</sub>O<sub>3</sub> are shown at Fig. 1 and Fig.2 as the representative. All the CuFe<sub>2</sub>O<sub>4</sub> base-ceramics crystallized in tetragonal structure (JCPDS No.34-0425). In all XRD profiles peak of Fe<sub>2</sub>O<sub>3</sub> was observed indicating that a part of the Fe<sub>2</sub>O<sub>3</sub> could not form CuFe<sub>2</sub>O<sub>4</sub> solid solution. Peak from Al<sub>2</sub>O<sub>3</sub> was not

observed in all XRD profiles. This fact gives a possibility that the Al<sub>2</sub>O<sub>3</sub> was dissolved.

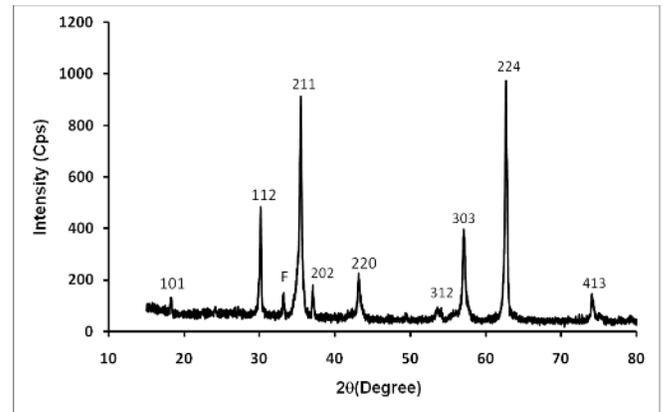


Fig.1. XRD profile of CuFe<sub>2</sub>O<sub>4</sub> base-ceramic (40CuO-60Fe<sub>2</sub>O<sub>3</sub>) without Al<sub>2</sub>O<sub>3</sub> addition. F is peak from Fe<sub>2</sub>O<sub>3</sub>.

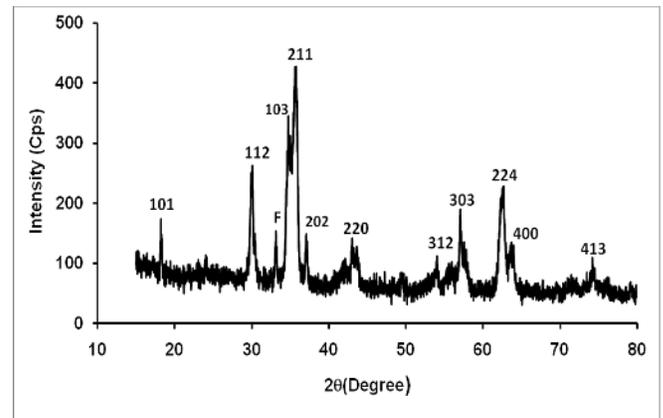


Fig.2. XRD profile of CuFe<sub>2</sub>O<sub>4</sub> base-ceramic (40CuO-60Fe<sub>2</sub>O<sub>3</sub>) with 1 mole % Al<sub>2</sub>O<sub>3</sub>. F is peak from Fe<sub>2</sub>O<sub>3</sub>.

### 4.2 Electrical Characteristics

Curves of ln Resistivity vs 1/T in Fig. 3 are linear indicating that the CuFe<sub>2</sub>O<sub>4</sub> base-ceramics obey the NTC characteristic of the thermistor. As shown in Table 1, thermistor constant (B) and sensitivity ( $\alpha$ ) of the ceramics added with Al<sub>2</sub>O<sub>3</sub> are larger than those of the ceramics without Al<sub>2</sub>O<sub>3</sub>. This means that the addition of Al<sub>2</sub>O<sub>3</sub> increased the thermistor constant and sensitivity of the ceramics. Large B and  $\alpha$  is good for the NTC thermistor. The value of B and  $\alpha$  of the ceramics fit the market requirement (larger than or equal 2000K(B) and 2.2%/K( $\alpha$ , $\alpha$ )). The

mechanism of the increasing the thermistor constant and sensitivity is as follow. The  $\text{Al}_2\text{O}_3$  segregates at grain boundaries and impeded grain growth during sintering. The ceramics then contains small grains or many grain boundaries. Because the grain boundaries are scattering center for electron, the electrical resistivity and thermistor constant of the ceramics increase.

The ageing test result is shown in Fig. 4. As can be seen, for sample without  $\text{Al}_2\text{O}_3$ , from 0 to 100 hours ageing test, the resistivity change rapidly following the aging time. From 100 hours to 1000 hours, the resistance tends to stable. Below 100 hours, the ions in the ceramics tend to rearrange during heating at  $150^\circ\text{C}$ [12]. Here, some  $\text{Fe}^{2+}$  oxidizes to  $\text{Fe}^{3+}$ . So, the resistance has not been stable. In the range 100-1000hours, the resistance tends to stable though slightly fluctuates. The time to reach a stability condition is different depending on the concentration of  $\text{Al}_2\text{O}_3$ . For sample added with  $\text{Al}_2\text{O}_3$  the time to reach the stable condition is about 200 hours. It is clear that the addition  $\text{Al}_2\text{O}_3$  worsen the stability. The fluctuation of the resistance becomes larger as the concentration of  $\text{Al}_2\text{O}_3$  increases. The value of 200 hours

can be taken as a time for preparing a stable  $\text{CuFe}_2\text{O}_4$  base-ceramics for NTC thermistor.

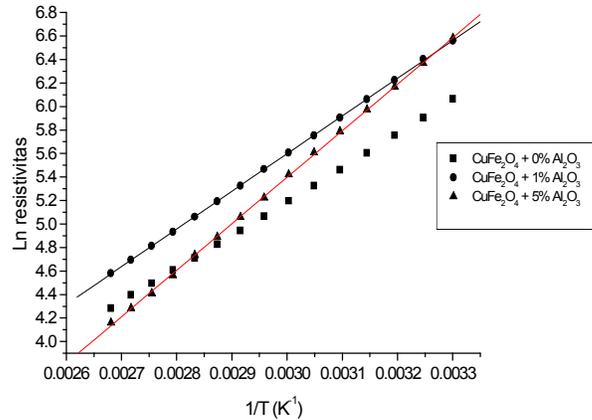


Fig.3. The relation between  $\ln$  Electrical Resistivity and  $1/T$ .

Table 1. Electrical characteristics of the ceramics.

No.	Penambahan $\text{Al}_2\text{O}_3$ (mole %)	B ( $^\circ\text{K}$ )	$\alpha$ ( $\%/^\circ\text{K}$ )
1.	0	2862	3,22
2.	1	3208	3,61
3.	5	3958	4,46

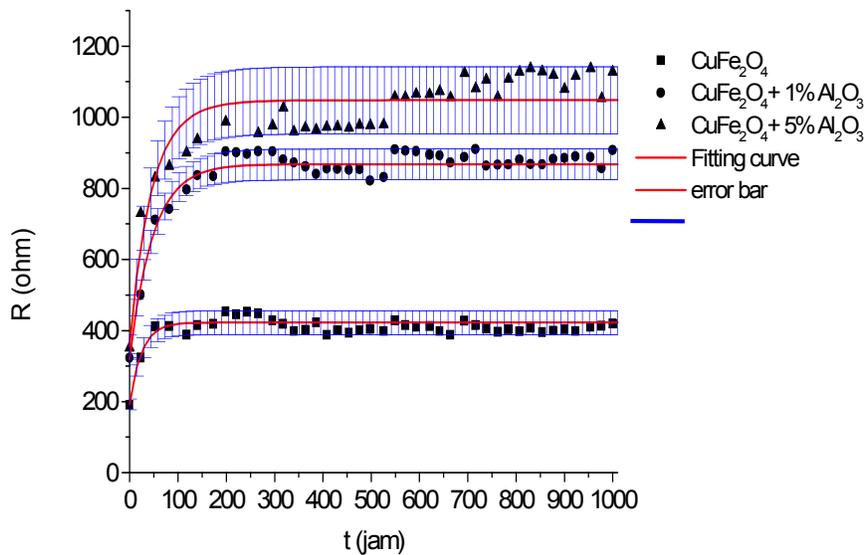


Fig. 4. Electrical resistance as function of time as the result of ageing test.

## 5. CONCLUSION

All  $\text{CuFe}_2\text{O}_4$  base-ceramic crystallized in tetragonal structure. Thermistor constant (B) and sensitivity (a) of the  $\text{CuFe}_2\text{O}_4$  base-ceramics increase with the increase of  $\text{Al}_2\text{O}_3$  concentration. This means that the addition of  $\text{Al}_2\text{O}_3$  can be used as a controlling parameter. However, the addition of  $\text{Al}_2\text{O}_3$  decreases the electrical stability of the  $\text{CuFe}_2\text{O}_4$  base-ceramics. Only sample without  $\text{Al}_2\text{O}_3$  and that added with 1 mole %  $\text{Al}_2\text{O}_3$  fit the electrical stability condition. Heating at  $150^\circ\text{C}$  for 200 hours can be used to make  $\text{CuFe}_2\text{O}_4$  base-ceramic stable electrically.

## ACKNOWLEDGMENT

The authors wish to acknowledge their deep gratitude to DIKTI, Department of National Education of Indonesian Government for financial support under hibah PEKERTI program with contract No. 014/SPP/PP/DP2M/II/2006 April 24, 2006.

## REFERENCES

- [1]. BetaTHERM Sensors [on line]. Available: <http://www.betatherm.com>.
- [2]. E.S. Na, U.G. Paik, S.C. Choi, "The effect of a sintered microstructure on the electrical properties of a Mn-Co-Ni-O thermistor", *Journal of Ceramic Processing Research*, Vol.2, No. 1, pp 31-34, 2001.
- [3]. Y. Matsuo, T. Hata, T. Kuroda, "Oxide thermistor composition, US Patent 4,324,702, April 13, 1982
- [4]. J. H. Jung, O. S. Yoon, Y. K. Hong, J. K. Lee, "Metal oxide group thermistor material", US Patent 5,246,628, September 21, 1993.
- [5]. K. Hamada, H. Oda, "Thermistor composition", US Patent 6,270,693, August 7, 2001.
- [6]. K. Park, "Microstructure and electrical properties of  $\text{Ni}_{1.0}\text{Mn}_{2-x}\text{Zr}_x\text{O}_4$  ( $0 \leq x \leq 1.0$ ) negative temperature coefficient thermistors", *Materials Science and Engineering*, B104, pp. 9-14, 2003.
- [7]. K. Park, D.Y. Bang, "Electrical properties of Ni-Mn-Co-(Fe) oxide thick film NTC thermistors", *Journal of Materials Science: Materials in Electronics*, Vol.14, pp. 81-87, 2003.
- [8]. S.G. Fritsch, J. Salmi, J. Sarrias, A. Rousset, S. Schuurman, Andre Lannoo, "Mechanical properties of nickel manganites-based ceramics used as negative temperature coefficient thermistors", *Materials Research Bulletin*, Vol. 39, pp. 1957-1965, 2004.
- [9]. R. Schmidt, A. Basu, A.W. Brinkman, Production of NTC thermistor devices based on  $\text{NiMn}_2\text{O}_{4+\delta}$ ", *Journal of The European Ceramic Society*, Vol. 24, pp. 1233-1236, 2004.
- [10]. K. PARK, I.H. HAN, "Effect of  $\text{Al}_2\text{O}_3$  addition on the microstructure and electrical properties of  $(\text{Mn}_{0.37}\text{Ni}_{0.3}\text{Co}_{0.33-x}\text{Al}_x)\text{O}_4$  ( $0 \leq x \leq 0.03$ ) NTC thermistors", *Materials Science and Engineering*, B119, pp. 55-60, 2005.
- [11]. Wiendartun, D. G. Syarif, The Effect of  $\text{TiO}_2$  Addition on the Characteristics of  $\text{CuFe}_2\text{O}_4$  Ceramics for NTC Thermistors, International Conference on Mathematics and Natural Sciences (ICMNS) 2006, ITB, Bandung, October 2006.
- [12]. M. M. Vakiv, Aging Behaviour of Electrical Resistance in Manganite NTC ceramics, *Jurnal of the European Ceramics Society*, 2004.